TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π-MOSV)

2SK3373

Switching Regulator and DC/DC Converter Applications Motor Drive Applications

• Low drain-source ON-resistance: $R_{DS (ON)} = 2.9 \text{ m}\Omega \text{ (typ.)}$

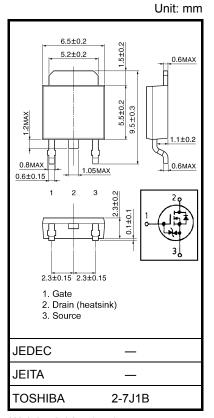
• High forward transfer admittance: |Yfs| = 1.7 S (typ.)

• Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 500 V)

• Enhancement model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Charac	teristic	Symbol	Rating	Unit
Drain-source voltag	je	V_{DSS}	500	V
Drain-gate voltage	$(R_{GS} = 20 \text{ k}\Omega)$	V_{DGR}	500	V
Gate-source voltage	e	V_{GSS}	±30	V
Drain current	DC (Note 1)	ID	2	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	5	Α
	Pulse (t = 100 μs) (Note 1)	I _{DP}	12	
Drain power dissipa	ation (Tc = 25°C)	P_{D}	20	W
Single-pulse avalanche energy (Note 2)		E _{AS}	112	mJ
Avalanche current		I _{AR}	2	Α
Repetitive avalanch	ne energy (Note 3)	E _{AR}	2	mJ
Channel temperatu	re	T _{ch}	150	°C
Storage temperatur	e range	T _{stg}	-55 to150	°C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	6.25	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 48.4 mH, $R_G = 25 \Omega$, $I_{AR} = 2 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

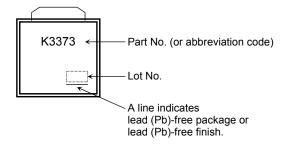
Electrical Characteristics (Ta = 25°C)

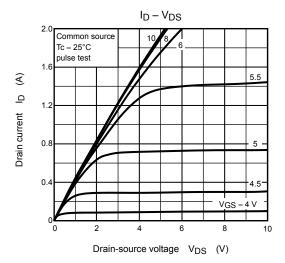
Chara	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cutoff curre	nt	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μА
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	500	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source ON-	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1 A	_	2.9	3.2	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1 A	8.0	1.7	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	380	_	pF
Reverse transfer capacitance		C _{rss}		_	40	_	
Output capacitance		Coss		_	120	_	
Switching time	Rise time	t _r	$V_{GS} = 10 \text{ V}$ $0 $	_	15	_	ns
	Turn-on time	t _{on}		_	25	_	
	Fall time	t _f		_	20	_	
	Turn-off time	t _{off}		_	80	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	9	_	nC
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$		5	_	
Gate-drain ("Miller") charge		Q _{gd}			4	_	

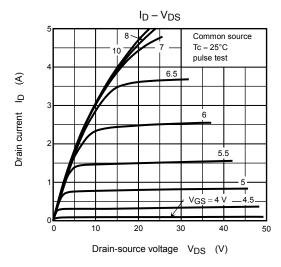
Source-Drain Ratings and Characteristics (Ta = 25°C)

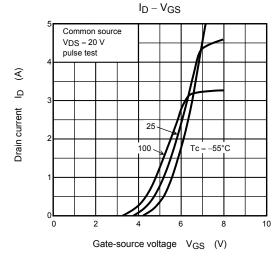
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	_	_	_	2	Α
Pulse drain reverse current (Note 1)	I _{DRP}	t = 1 ms	_	_	5	Α
ruise diain levelse cullent (Note 1)	I _{DRP}	t = 100 μs	_	_	12	
Forward voltage (diode)	V _{DSF}	$I_{DR} = 2 A$, $V_{GS} = 0 V$	_	_	-1.5	V
Reverse recovery time	t _{rr}	$I_{DR} = 2 \text{ A}, V_{GS} = 0 \text{ V},$	_	1000	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/μs		3.5	_	μС

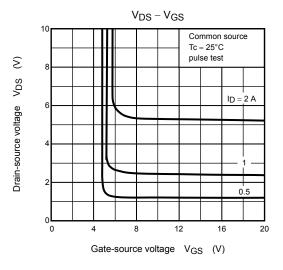
Marking

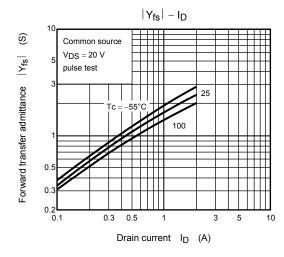


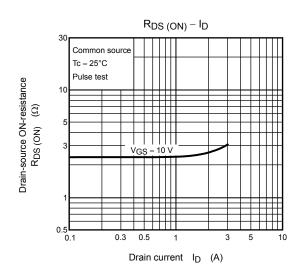




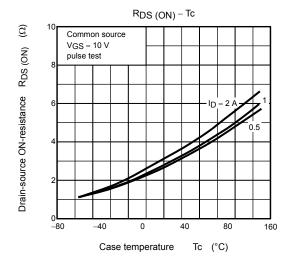


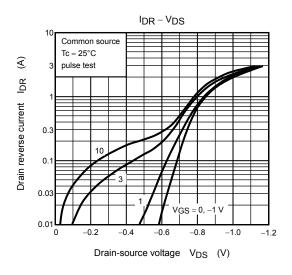


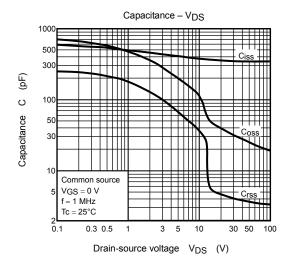


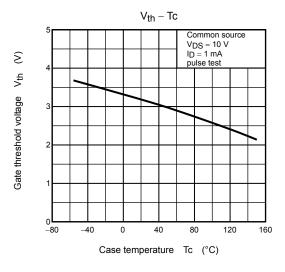


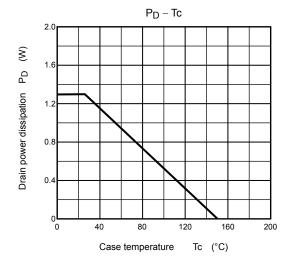
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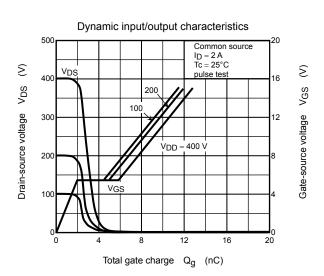


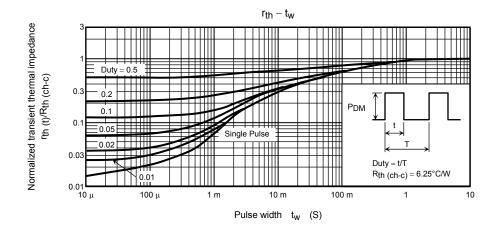


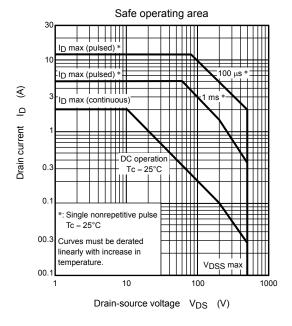


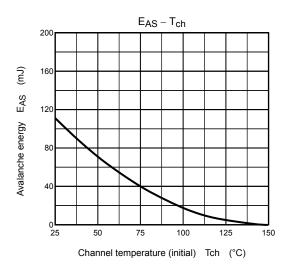


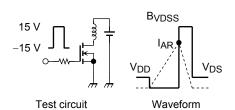












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 48.4~mH \end{aligned} \qquad E_{AS} &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right) \end{aligned}$$

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